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E-FILED - 12/23/08

UNITED STATES DISTRICT COURT
NORTHERN DISTRICT OF CALIFORNIA
SAN JOSE DIVISION

RAMBUS INC.,
Plaintiff,
v.
HYNIX SEMICONDUCTOR INC.,
HYNIXSEMICONDUCTOR AMERICA
INC., HYNIX SEMICONDUCTOR
MANUFACTURING AMERICA INC.,
SAMSUNG ELECTRONICS CO., LTD.,
SAMSUNG ELECTRONICS AMERICA,
INC., SAMSUNG SEMICONDUCTOR,
INC., SAMSUNG AUSTIN
SEMICONDUCTOR, L.P.,
NANYA TECHNOLOGY
CORPORATION, NANYA
TECHNOLOGY CORPORATION U.S.A.,
Defendants.

Case No. C 05-00334 RMW

**[] ORDER GRANTING
MISCELLANEOUS ADMINISTRATIVE
REQUEST PURSUANT TO CIVIL LOCAL
RULES 7-10 AND 79-5 TO SEAL:**

- 1. CONFIDENTIAL VERSION OF MICRON
AND SAMSUNG'S REPLY IN FURTHER
SUPPORT OF THEIR MOTION FOR
SUMMARY JUDGMENT REGARDING
CERTAIN DAMAGES ISSUES AND
RELATED DAUBERT MOTIONS TO
PRECLUDE DAVID J. TEECE FROM
OFFERING TESTIMONY ON SUCH
ISSUES (MSJ NO. 8);**
- 2. EXHIBITS A & B TO THE
DECLARATION OF DAVID J. LENDER
IN SUPPORT THEREOF;**
- 3. CONFIDENTIAL VERSION OF MICRON
AND SAMSUNG'S REPLY IN FURTHER
SUPPORT OF THEIR JOINT DAUBERT
MOTION AND MOTIONS IN LIMINE
REGARDING CERTAIN DAMAGES
ISSUES (DAUBERT NO. 9)**

Honorable Ronald M. Whyte

RAMBUS INC.,
v.
Plaintiff,
SAMSUNG ELECTRONICS CO., LTD.,
SAMSUNG ELECTRONICS AMERICA, INC.,
SAMSUNG SEMICONDUCTOR, INC.,
SAMSUNG AUSTIN SEMICONDUCTOR,
L.P.,
Defendants.

Case No. C 05-02298 RMW

RAMBUS INC.,
Plaintiff,
v.
MICRON TECHNOLOGY, INC. and MICRON
SEMICONDUCTOR PRODUCTS, INC.,
Defendants.

Case No. C 06-00244 RMW

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18 SAMSUNG ELECTRONICS CO., LTD.,
19 SAMSUNG ELECTRONICS AMERICA, INC.,
20 SAMSUNG SEMICONDUCTOR, INC., and
21 SAMSUNG AUSTIN SEMICONDUCTOR, L.P.

As set forth in defendants Micron Technology, Inc., Micron Semiconductor Products, Inc., Samsung Electronics Co., LTD., Samsung Electronics America, Inc., Samsung Semiconductor, Inc., and Samsung Austin Semiconductor, L.P.'s Miscellaneous Administrative Request Pursuant To Civil Local Rules 7-10 and 79-5 To Seal Documents, Defendants lodged with the Court the following documents in connection with their Reply In Further Support Of Their Motion For Summary Judgment Regarding Certain Damages Issues And Related Daubert Motions To Preclude David J. Teece From Offering Testimony On Such Issues (MSJ No. 8) and Reply In Further Support Of Their Joint Daubert Motion And Motions In Limine Regarding Certain Damages Issues (Daubert No. 9):

- The Confidential version of Micron Technology, Inc., Micron Semiconductor Products, Inc., Samsung Electronics Co., Ltd., Samsung Electronics America, Inc., Samsung Semiconductor, Inc., And Samsung Austin Semiconductor, L.P.'s Reply In Further Support Of Their Motion For Summary Judgment Regarding Certain Damages Issues And Related Daubert Motions To Preclude David J. Teece From Offering Testimony On Such Issues (MSJ No. 8).

- **Exhibit A** to the Declaration of David J. Lender in Support of Micron and Samsung's Confidential Reply MSJ No. 8. This exhibit is a true and correct copy of excerpts from the expert report of Stephen D. Prowse, Ph.D, dated 9/26/2008.

- **Exhibit B** to the Declaration of David J. Lender in Support of Micron and Samsung's Confidential Reply MSJ No. 8. This exhibit is a true and correct copy of excerpts from the deposition of David J. Teece, dated 10/21/2008.

- The Confidential version of Micron Technology, Inc., Micron Semiconductor Products, Inc., Samsung Electronics Co., Ltd., Samsung Electronics America, Inc., Samsung Semiconductor, Inc., And Samsung Austin Semiconductor, L.P.'s Reply In Further Support Of Their Joint Daubert Motion And Motions In Limine Regarding Certain Damages Issues (Daubert No. 9).

Having considered Defendants' Miscellaneous Administrative Request, and good cause appearing,

1 IT IS HEREBY ORDERED that the Confidential version of Micron Technology,
2 Inc., Micron Semiconductor Products, Inc., Samsung Electronics Co., Ltd., Samsung Electronics
3 America, Inc., Samsung Semiconductor, Inc., And Samsung Austin Semiconductor, L.P.'s Reply
4 In Further Support Of Their Motion For Summary Judgment Regarding Certain Damages Issues
5 And Related Daubert Motions To Preclude David J. Teece From Offering Testimony On Such
6 Issues (MSJ No. 8) and Exhibits A & B to the Declaration of David J. Lender in Support thereof
7 are to be filed under seal.

8 IT IS HEREBY ORDERED that the Confidential version of Micron Technology,
9 Inc., Micron Semiconductor Products, Inc., Samsung Electronics Co., Ltd., Samsung Electronics
10 America, Inc., Samsung Semiconductor, Inc., And Samsung Austin Semiconductor, L.P.'s Reply
11 In Further Support Of Their Joint Daubert Motion And Motions In Limine Regarding Certain
12 Damages Issues (Daubert No. 9) is to be filed under seal.

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15 Dated: 12/23/08



16 The Honorable Ronald M. Whyte
United States District Court Judge

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